OCT 2 6 2001

CONTINUED PROSECUTION APPLICATION (CPA) REQUEST TRANSMITTAL

(Only for Continuation or Divisional applications under 37 CFR 1.53(d))

Address to: **Assistant Commissioner for Patents**

Box CPA Washington, DC 20231

| Attorney Docket No. | 8543-004-27 CIP TECON 34 2001 | |
|---------------------|-------------------------------|--|
| First Inventor | Marvin LIAO | |
| Group Art Unit | 2814 CENTER 200 | |
| Examiner | T. Quach | |

| (00) | ntinu | a request for a continuation or divisional application under 37 CFR 1.53(d) led prosecution application (CPA)) of prior application number 08/825,360 |
|------|-------|--|
| THEC | ı on | March 28, 1997 entitled INTERCONNECT STRUCTURE FOR USE IN AN INTEGRATED CIRCUIT |
| 1. | | Enter the amendment(s) filed on |
| | | under 37 CFR 1.116 in the prior nonprovisional application. |
| 2. | | A Preliminary Amendment is enclosed. |
| 3. | | This application is filed by fewer than all the inventors named in the prior application, 37 CFR 1.53 (d)(4) |
| | a. | □ DELETE the following inventor(s) named in the prior nonprovisional application: |
| | b. | ☐ The inventor(s) to be deleted are set forth on a separate sheet attached hereto. |
| 4. | | A new power of attorney or authorization of agent (PTO/SB/81) is enclosed. |
| 5. | | An Information Disclosure Statement (IDS) is enclosed, along with: |
| | a. | □ Form PTO-1449 |
| | b. | □ Copies of Cited Documents |
| 6. | | Applicant(s) claim(s) small entity status. |
| 7. | | A Fee Transmittal is enclosed. |
| 8. | | A check in the amount of \$2,916.00 |
| 9. | | The Commissioner is hereby authorized to charge any underpayment for the papers being filed herewith and for which no check is enclosed or credit any overpayment to Deposit Account No. 50-1442 . |
| | | If these papers are not considered timely filed by the Patent and Trademark Office, then a request is hereby made unde 37 CFR 1.136 for the necessary extension of time in the parent case. Any fees required for such an extension of time may be charged to Deposit Account No. 50-1442 . |
| 10. | | Applicant(s) request(s) suspension of action under 37 CFR 1.103(b) for a period of months (not to exceed 3 months) and the fee under 37 CFR 1.17(i) is enclosed). |
| 11. | | New Attorney Docket Number, if desired |

CORRESPONDENCE ADDRESS

Supervisor, Patent Prosecution Services PIPER MARBURY RUDNICK & WOLFE LLP 1200 Nineteenth Street, N.W. Washington, D.C. 20036-2412 Telephone No. (202) 861-3900 Facsimile No. (202) 223-2085

| Name | Jerohd I. Schneider | | Registration No. | | 24,765 | |
|-----------|---------------------|------|------------------|-----------|--------------|--|
| Signature | Chrosof 7. Khunder | Date | October 26, 2001 | Telephone | 202-861-3900 | |
| Name | | | Registration No. | | | |

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12.

Other: Request for Extension of Time

710.00 09 216.00 09



FEE TRANSMITTAL

Docket No. 8543-004-27 CIP Serial No. 08/825,360 Filing Date March 28, 1997 Inventor(s) Marvin LIAO et al.

SUBTOTAL (3)

\$1,960.00

Group Art Unit 2814 TOTAL AMOUNT OF PAYMENT \$2,916.00 Examiner T. Quach Applicant claims small entity status. 1. 🗆 FEE CALCULATION (continued) Charge any **UNDERPAYMENT** or credit any **OVERPAYMENT** 3. ADDITIONAL FEES in the indicated fees to Deposit Account No. 50-1442. Large Entity Small Entity Fee Description Charge the indicated fees to Deposit Account No. 50-1442. Fee Code Fee (\$) Check enclosed. Fee Code Fee Paid (\$) **FEE CALCULATION** 105 130 205 Surcharge-late filing fee or oath **BASIC FILING FEE** 127 50 227 25 Surcharge-late fee or cover sheet Large Entity Small Entity Fee Description 139 130 Non-English specification Fee (\$) Fee Code Fee Code 147 2520 Fee Paid 147 2520 Ex parte reexam. (\$) 101 740 201 370 Utility filing fee \$740.00 115 110 215 1-mo. ext. of time 106 330 206 165 Design filing fee 116 400 216 200 2-mo. ext. of time 107 510 207 255 Plant filing fee 117 920 217 460 3-mo, ext. of time 108 740 208 370 Reissue filing fee 118 1440 218 720 4-mo. ext. of time 114 160 214 Provisional filing fee 128 1960 228 980 5-mo, ext. of time \$1,960.00 SUBTOTAL (1) \$740.00 119 320 219 160 Notice of Appeal **EXTRA CLAIM FEES** 120 320 220 160 Appeal Brief tot. claims 32 20* 12 \$18 = 121 280 221 216 140 Request for Oral ind. claims 3* 0 2 х \$84 = 0 142 1280 242 640 Utility/Reissue Issue Fee Multiple Dependent Claims \$280 = 143 460 243 230 Design Issue Fee Large Entity Small Entity Fee Description 620 244 310 144 Plant Issue Fee Fee Fee Fee 122 122 Petitions to the Code (\$) Commissioner 103 18 203 9 Claims in excess of 20 126 180 126 180 IDS Submission 84 102 202 42 Independent claims in excess of 3 581 40 581 40 Assignment 104 280 204 140 Multiple dependent claim, if not paid 179 740 279 370 For Filing RCE 109 84 209 42 *Reissue independent claims over original patent 169 900 169 900 **Expedited Design** 110 18 210 9 *Reissue claims in excess of 20 and over original OTHER (indicate below): SUBTOTAL (2) \$216.00 * or number previously paid, if greater; For Reissues, see above

| Name | Jerp19 I. Schneider | Registration No. | | 24,765 | |
|-----------|---------------------|------------------|------------------|-----------|--------------|
| Signature | Seul | Date | October 26, 2001 | Telephone | 202-861-3900 |
| Name | | Registration No. | | | |

DOCKET NO. 8543-004-27 CIP

RECEIVED

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Marvin LIAO et al.

SERIAL NO.: 08/825,360

FOR:

FILING DATE: March 28, 1997

EXAMINER: T. Quach 1/2000 INTERCONNECT STRUCTURE FOR USE IN AN INTEGRATED CIRCUMMENTER PRELIMINARY AND STRUCTURE PROPRIEME PRELIMINARY AND STRUCTURE PROPRIEME PROPRIE

ASSISTANT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231

SIR:

Prior to examination on the merits, please amend the above-referenced application as follows.

IN THE CLAIMS

Please amend claims 21 and 48 as follows:

- 21. (Twice Amended) A method for forming a structure in an integrated circuit, said structure extending from a conductive surface through a channel having inner walls extending above said conductive surface, said method including the steps of:
- (a) depositing a layer of a refractory metal on said conductive surface and said inner walls of said channel;
- (b) forming a layer of a metal nitride on said layer of said refractory metal, wherein said layer of said metal nitride has a thickness xtending from said layer of said refractory metal of less than 130 Å;
- (c) said metal nitride layer being of greater thickness than said layer of refractory material; and